RENESAS

HD74LS26

Quadruple 2-input High-voltage Interface Positive NAND Gates

REJ03D0402-0200 Rev.2.00 Feb.18.2005

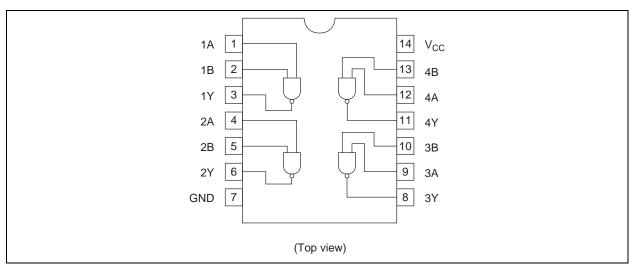
Features

• Ordering Information

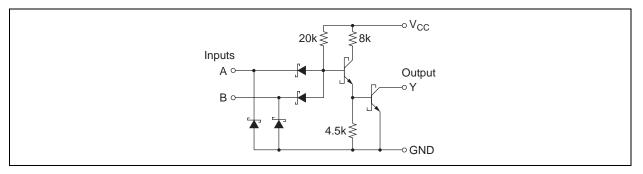
Part Name	Package Type	Package Code (Previous Code)	Package Abbreviation	Taping Abbreviation (Quantity)
HD74LS26P	DILP-14 pin	PRDP0014AB-B (DP-14AV)	Р	—
HD74LS26FPEL	SOP-14 pin (JEITA)	PRSP0014DF-B (FP-14DAV)	FP	EL (2,000 pcs/reel)

Note: Please consult the sales office for the above package availability.

Pin Arrangement



Circuit Schematic (1/4)





Absolute Maximum Ratings

Item	Symbol	Ratings	Unit
Supply voltage	V _{CC}	7	V
Input voltage	V _{IN}	7	V
Power dissipation	PT	400	mW
Storage temperature	Tstg	-65 to +150	°C

Note: Voltage value, unless otherwise noted, are with respect to network ground terminal.

Recommended Operating Conditions

ltem	Symbol	Min	Тур	Max	Unit
Supply voltage	Vcc	4.75	5.00	5.25	V
Output voltage	V _{OH}	—	-	15	V
Output current	I _{OL}	_	_	8	mA
Operating temperature	Topr	-20	25	75	°C

Electrical Characteristics

 $(Ta = -20 \text{ to } +75 \ ^{\circ}\text{C})$

ltem	Symbol	min.	typ.*	max.	Unit	Condition
	VIH	2.0	—	—	V	
Input voltage	VIL	—	—	0.8	V	
Output voltage	V _{OL}	—	—	0.4	V	$I_{OL} = 4 \text{ mA}$ $V_{CC} = 4.75 \text{ V}, \text{ V}_{H} = 2 \text{ V}$
		—	—	0.5		$I_{OL} = 8 \text{ mA}$ $V_{CC} = 4.75 \text{ V}, \text{ V}_{H} = 2 \text{ V}$
Input current	I _{IH}	—	—	20	μΑ	$V_{CC} = 5.25 \text{ V}, \text{ V}_{I} = 2.7 \text{ V}$
	I _{IL}	—	—	-0.4	mA	$V_{CC} = 5.25 \text{ V}, \text{ V}_{I} = 0.4 \text{ V}$
	lı –	—	—	0.1	mA	$V_{CC} = 5.25 \text{ V}, \text{ V}_{I} = 7 \text{ V}$
Output current	I _{OH}	—	—	50	μΑ	$V_{OH} = 12 V$ $V_{CC} = 4.75 V, V_{IL} = 0.8 V$
		—	—	1	mA	$V_{OH} = 15 \text{ V}$ $V_{CC} = 4.75 \text{ V}, \text{ V}_{IL} = 0.8 \text{ V}$
Supply current	I _{CCH}	—	0.8	1.6	mA	V _{CC} = 5.25 V
	I _{CCL}	—	2.4	4.4	mA	V _{CC} = 5.25 V
Input clamp voltage	V _{IK}	_	_	-1.5	V	$V_{CC} = 4.75 \text{ V}, \text{ I}_{IN} = -18 \text{ mA}$

Note: $V_{CC} = 5 V$, Ta = $25^{\circ}C$

Switching Characteristics

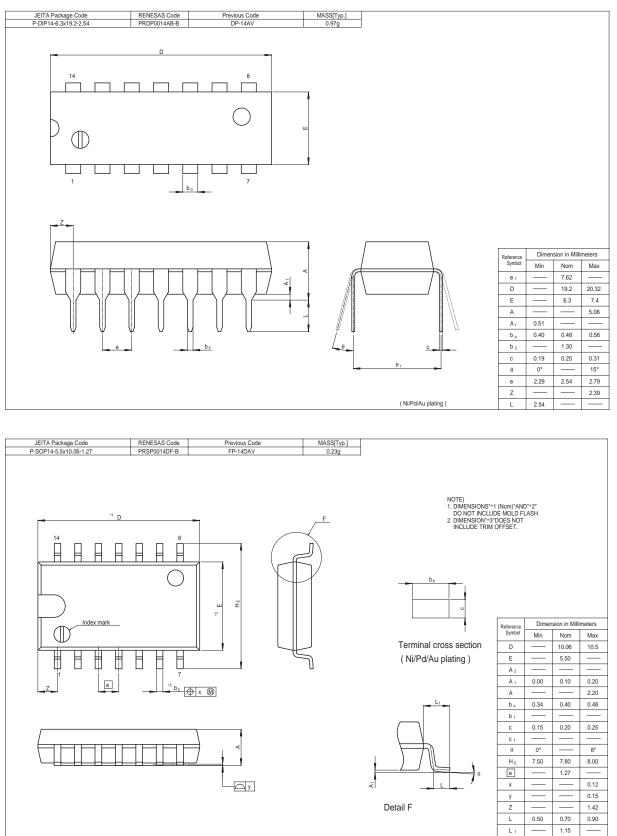
 $(V_{CC} = 5 V, Ta = 25^{\circ}C)$

Item	Symbol	min.	typ.	max.	Unit	Condition
Propagation delay time	t _{PLH}		17	32	ns	$C_{L} = 15 \text{ pF}, R_{L} = 2 \text{ k}\Omega$
	t _{PHL}	_	15	28	ns	$O_{L} = 10 \text{ pr}, N_{L} = 2 \text{ K}_{2}$

Note: Refer to Test Circuit and Waveform of the Common Item "TTL Common Matter (Document No.: REJ27D0005-0100)".



Package Dimensions



Rev.2.00, Feb.18.2005, page 3 of 3



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